

* Drain current limited by maximum junction temperature.



Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC I	PARAMETERS					
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =10mA, V _{GS} =0V, T _J =25°C	500			
		I _D =10mA, V _{GS} =0V, T _J =150°C		600		V
BV _{DSS} /∆TJ	Breakdown Voltage Temperature Coefficient	I _D =10mA, V _{GS} =0V		0.56		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =500V, V _{GS} =0V			10	μΑ
		V _{DS} =400V, T _J =125°C			100	
I _{GSS}	Gate-Body leakage current	$V_{DS}=0V, V_{GS}=\pm 30V$			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =5V, Ι _D =250μΑ	2.5	3.5	4.2	V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =2.5A		1.5	1.8	Ω
g fs	Forward Transconductance	V _{DS} =40V, I _D =2.5A		4		S
V _{SD}	Diode Forward Voltage	I _S =5A,V _{GS} =0V		0.93	1.6	V
I _S	Maximum Body-Diode Continuous Current				5	Α
I _{SM}	Maximum Body-Diode Pulsed Current				13	Α
DYNAMI	C PARAMETERS					
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =25V, f=1MHz	350	440	530	pF
C _{oss}	Output Capacitance		35	50	65	pF
C _{rss}	Reverse Transfer Capacitance		2.5	4.5	6.5	pF
R _g	Gate resistance	V_{GS} =0V, V_{DS} =0V, f=1MHz	1.7	3.4	5.2	Ω
SWITCH	NG PARAMETERS					
Qg	Total Gate Charge	V _{GS} =10V, V _{DS} =400V, I _D =5A	8	11	15	nC
Q _{gs}	Gate Source Charge			2.7		nC
Q_{gd}	Gate Drain Charge			3.8		nC
t _{D(on)}	Turn-On DelayTime			18		ns
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =250V, I_{D} =5A,		33		ns
t _{D(off)}	Turn-Off DelayTime	R _G =25Ω		31		ns
t _f	Turn-Off Fall Time			26		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =5A,dI/dt=100A/μs,V _{DS} =100V		87	145	ns
Q _{rr}	Body Diode Reverse Recovery Charge	e I _F =5A,dI/dt=100A/μs,V _{DS} =100V		0.2	0.4	μC

A. The value of R $_{0,JA}$ is measured with the device in a still air environment with T $_A$ =25° C.

B. The power dissipation P_D is based on T_{J(MAX)}=150° C, using junction-to-case thermal resistance, and is more useful in setting the upper

dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}=150^{\circ}$ C, Ratings are based on low frequency and duty cycles to keep initial $T_{J}=25^{\circ}$ C.

D. The R _{0JA} is the sum of the thermal impedance from junction to case R _{0JC} and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300 µs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $T_{J(MAX)}$ =150° C. The SOA curve provides a single pulse rating.

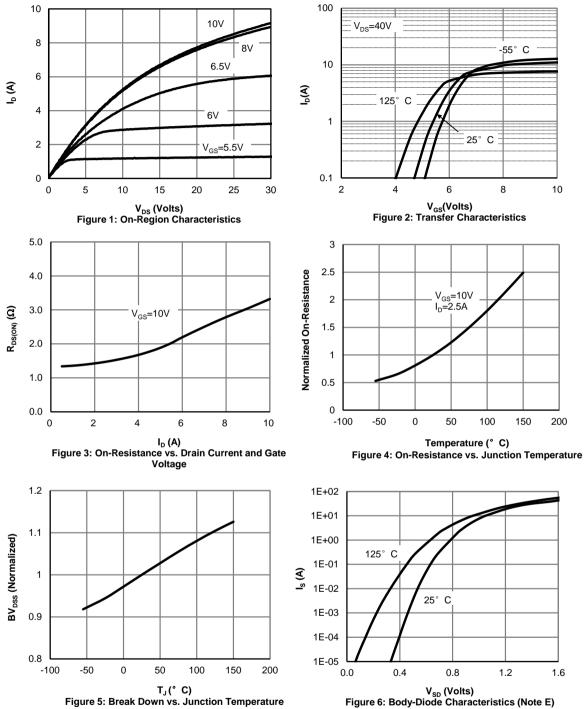
G. L=60mH, I_{AS} =2.3A, V_{DD} =150V, R_G =25 Ω , Starting T_J =25 $^{\circ}$ C

APPLICATIONS OR USES AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS ARE NOT AUTHORIZED. AOS DOES NOT ASSUME ANY LIABILITY ARISING OUT OF SUCH APPLICATIONS OR USES OF ITS PRODUCTS. AOS RESERVES THE RIGHT TO MAKE CHANGES TO PRODUCT SPECIFICATIONS WITHOUT NOTICE. IT IS THE RESPONSIBILITY OF THE CUSTOMER TO EVALUATE SUITABILITY OF THE PRODUCT FOR THEIR INTENDED APPLICATION. CUSTOMER SHALL COMPLY WITH APPLICABLE LEGAL REQUIREMENTS, INCLUDING ALL APPLICABLE EXPORT CONTROL RULES, REGULATIONS AND LIMITATIONS.

AOS' products are provided subject to AOS' terms and conditions of sale which are set forth at: http://www.aosmd.com/terms_and_conditions_of_sale



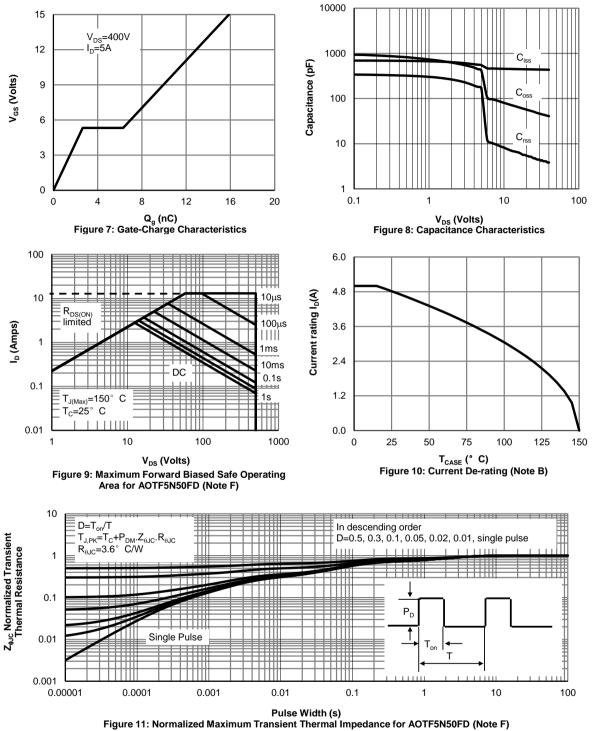
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



V_{SD} (Volts) Figure 6: Body-Diode Characteristics (Note E)

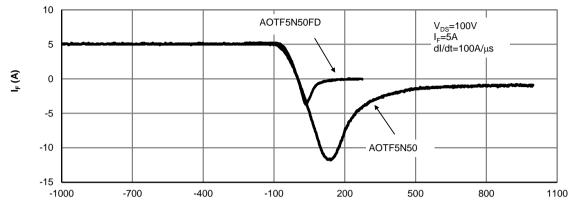


TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



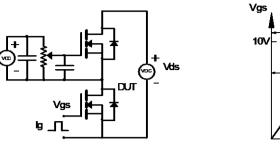
Trr (nS) Figure 12: Diode Recovery Characteristics

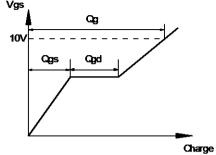


BV_{DSS}

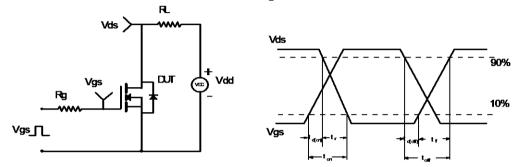
 I_{AR}

Gate Charge Test Circuit & Waveform

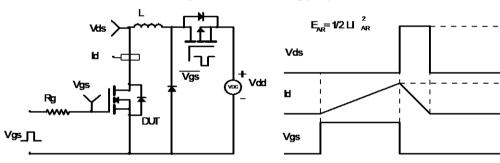




Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms

